

Product Data Sheet Type: FI311/SE

Group: HEATSINKS Board Level

For single mounting

Width :	46 mm
Height :	12.7 mm
Length :	46 mm
Minimum thermal resistance :	7 K/W
For device :	TO 3 TO 66 TO 9 SOT 32
Device mounted by :	Screw
Heatsink mounted by :	Srew-On
Surface :	Black Anodised
Material :	Al99,5



Finger shaped heatsink, with universal hole pattern,
for semiconductor case TO3; TO66; SOT9; SOT32 and TO 220.
Space saving construction.
Turbulence in every installation position.

